## **AMENDMENTS TO THE SPECIFICATION**

Please replace paragraph number [0001] with the following amended paragraph:

[0001] This patent application is a continuation claiming priority from a

patent application having serial number 10/284,867 titled "Slotted Substrates and

Methods and Systems for Forming Same" filed 10/31/2002, and issued as patent

number [\_\_\_\_\_] US 6,672,712 B1.